

January 2001 Revised August 2001

74LCX32374

Low Voltage 32-Bit D-Type Flip-Flop with 5V Tolerant Inputs and Outputs (Preliminary)

General Description

The LCX32374 contains thirty-two non-inverting D-type flip-flops with 3-STATE outputs and is intended for bus oriented applications. The device is byte controlled. A buffered clock (CP) and Output Enable $\overline{(OE)}$ are common to each byte and can be shorted together for full 32-bit operation

The LCX32374 is designed for low voltage (2.5V or 3.3V) V_{CC} applications with capability of interfacing to a 5V signal environment

The LCX32374 is fabricated with an advanced CMOS technology to achieve high speed operation while maintaining CMOS low power dissipation.

Features

- 5V tolerant inputs and outputs
- 2.3V-3.6V V_{CC} specifications provided
- \blacksquare 6.2 ns t_{PD} max (V_{CC} = 3.3V), 20 μ A I_{CC} max
- Power down high impedance inputs and outputs
- Supports live insertion/withdrawal (Note 1)
- \blacksquare ±24 mA output drive (V_{CC} = 3.0V)
- Uses patented noise/EMI reduction circuitry
- Latch-up performance exceeds 500 mA
- ESD performance:

Human body model > 2000V

Machine model > 200V

■ Packaged in plastic Fine-Pitch Ball Grid Array (FBGA) (Preliminary)

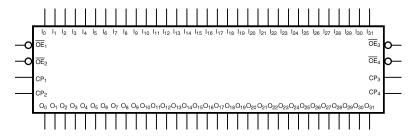
Note 1: To ensure the high-impedance state during power up or down, $\overline{\text{OE}}$ should be tied to V_{CC} through a pull-up resistor: the minimum value or the resistor is determined by the current-sourcing capability of the driver.

Ordering Code:

Order Number	Package Number	Package Description
74LCX32374GX	BGA96A	96-Ball Fine-Pitch Ball Grid Array (FBGA), JEDEC MO-205, 5.5mm Wide
(Note 2)	(Preliminary)	[Tape and Reel]

Note 2: BGA device available in Tape and Reel only.

Logic Symbol



Connection Diagram

	1	2	3	4	5	6
٧	0	0	0	0	0	0
В	0	0	0	0	0	0
ပ	0	0	0	0	0	0
□	0	0	0	0	0	0
ш	0	0	0	0	0	0
щ	0	0	0	0	0	0
σ	0	0	0	0	0	0
I	0	0	0	0	0	0
7	0	0	0	0	0	0
¥	0	0	0	0	0	0
_	0	0	0	0	0	0
Σ	0	0	0	0	0	0
z	0	0	0	0	0	0
凸	0	0	0	0	0	0
ш	0	0	0	0	0	0
-	0	0	0	0	0	0

(Top Thru View)

Functional Description

The LCX32374 consists of thirty-two edge-triggered flip-flops with individual D-type inputs and 3-STATE true outputs. The device is byte controlled with each byte functioning identically, but independent of the other. The control pins can be shorted together to obtain full 32-bit operation. Each byte has a buffered clock and buffered Output Enable common to all flip-flops within that byte. The description which follows applies to each byte. Each flip-flop will store the state of their individual D inputs that meet the setup and hold time requirements on the LOW-to-HIGH Clock (CP $_{\rm n}$) transition. With the Output Enable $(\overline{\rm OE}_{\rm n})$ LOW, the contents of the flip-flops are available at the outputs. When $\overline{\rm OE}_{\rm n}$ is HIGH, the outputs go to the high impedance state. Operation of the $\overline{\rm OE}_{\rm n}$ input does not affect the state of the flip-flops.

Pin Descriptions

Pin Names	Description
OE _n	Output Enable Input (Active LOW)
CP _n	Clock Pulse Input
I ₀ -I ₃₁	Inputs
O ₀ -O ₃₁	Outputs

FBGA Pin Assignments

	1	2	3	4	5	6
Α	O ₁	O ₀	ŌE ₁	CP ₁	I ₀	I ₁
В	O ₃	02	GND	GND	l ₂	l ₃
С	O ₅	04	V_{CC}	V_{CC}	I ₄	I ₅
D	O ₇	O ₆	GND	GND	I ₆	I ₇
Е	O ₉	O ₈	GND	GND	I ₈	l ₉
F	O ₁₁	O ₁₀	V _{CC}	V _{CC}	I ₁₀	I ₁₁
G	O ₁₃	O ₁₂	GND	GND	I ₁₂	I ₁₃
Н	O ₁₄	O ₁₅	ŌE ₂	CP ₂	I ₁₅	I ₁₄
J	O ₁₇	O ₁₆	OE ₃	CP ₃	I ₁₆	I ₁₇
K	O ₁₉	O ₁₈	GND	GND	I ₁₈	I ₁₉
L	O ₂₁	O ₂₀	V_{CC}	V_{CC}	I ₂₀	l ₂₁
М	O ₂₃	O ₂₂	GND	GND	l ₂₂	l ₂₃
N	O ₂₅	O ₂₄	GND	GND	l ₂₄	l ₂₅
Р	O ₂₇	O ₂₆	V_{CC}	V_{CC}	I ₂₆	l ₂₇
R	O ₂₉	O ₂₈	GND	GND	I ₂₈	l ₂₉
T	O ₃₀	O ₃₁	ŌE ₄	CP ₄	l ₃₁	I ₃₀

Truth Table

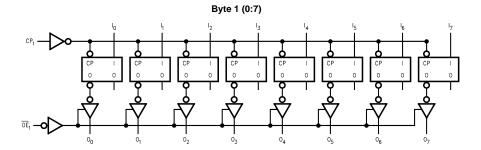
	Inputs		Outputs
CP _n	OE _n	I _n	O _n
~	L	Н	Н
~	L	L	L
L	L	Χ	O ₀
Х	Н	Χ	Z

X = Immaterial

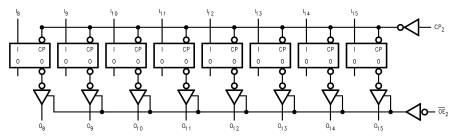
Z = High Impedance

 $O_0 = Previous O_0$ before HIGH-to-LOW of CP

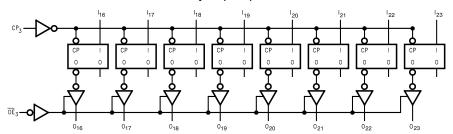
Logic Diagrams



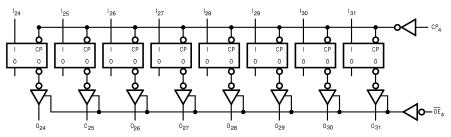
Byte 2 (8:15)



Byte 3 (16:23)



Byte 4 (24:31)



Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

Absolute Maximum Ratings(Note 3)

Symbol	Parameter	Value	Conditions	Units
V _{CC}	Supply Voltage	−0.5 to +7.0		V
VI	DC Input Voltage	−0.5 to +7.0		V
Vo	DC Output Voltage	-0.5 to +7.0	3-STATE	V
		-0.5 to $V_{CC} + 0.5$	Output in HIGH or LOW State (Note 4)	v
I _{IK}	DC Input Diode Current	-50	V _I < GND	mA
I _{OK}	DC Output Diode Current	-50	V _O < GND	mA
		+50	V _O > V _{CC}	IIIA
Io	DC Output Source/Sink Current	±50		mA
I _{CC}	DC Supply Current per Supply Pin	±100		mA
I _{GND}	DC Ground Current per Ground Pin	±100		mA
T _{STG}	Storage Temperature	-65 to +150		°C

Recommended Operating Conditions (Note 5)

Symbol	Parameter		Min	Max	Units
V _{CC}	Supply Voltage	Operating	2.0	3.6	V
		Data Retention	1.5	3.6	V
V _I	Input Voltage		0	5.5	V
Vo	Output Voltage	HIGH or LOW State	0	V _{CC}	V
		3-STATE	0	5.5	V
I _{OH} /I _{OL}	Output Current	$V_{CC} = 3.0V - 3.6V$		±24	
		$V_{CC} = 2.7V - 3.0V$ $V_{CC} = 2.3V - 2.7V$		±12	mA
		$V_{CC} = 2.3V - 2.7V$		±8	
T _A	Free-Air Operating Temperature		-40	85	°C
Δt/ΔV	Input Edge Rate, V _{IN} = 0.8V–2.0V, V _{CC} = 3.0V		0	10	ns/V

Note 3: The Absolute Maximum Ratings are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the Absolute Maximum Ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 5: Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

Symbol	Parameter	Conditions	V _{CC}	T _A = -40°C	Units	
Syllibol	Farameter	Conditions	(V)	Min	0.7 0.8 2 0.2 0.6 0.4 0.4 0.55 ±5.0	Units
V _{IH}	HIGH Level Input Voltage		2.3 – 2.7	1.7		V
			2.7 – 3.6	2.0		· ·
V _{IL}	LOW Level Input Voltage		2.3 – 2.7		0.7	V
			2.7 – 3.6		0.8	T *
V _{OH}	HIGH Level Output Voltage	$I_{OH} = -100 \mu A$	2.3 – 3.6	V _{CC} - 0.2		
		$I_{OH} = -8 \text{ mA}$	2.3	1.8		
		I _{OH} = -12 mA	2.7	2.2		V
		$I_{OH} = -18 \text{ mA}$	3.0	2.4		
		$I_{OH} = -24 \text{ mA}$	3.0	2.2		
V _{OL}	LOW Level Output Voltage	I _{OL} = 100 μA	2.3 – 3.6		0.2	
		$I_{OL} = 8 \text{ mA}$	2.3		0.6	
		$I_{OL} = 12 \text{ mA}$	2.7		0.4	V
		I _{OL} = 16 mA	3.0		0.4	
		I _{OL} = 24 mA	3.0		0.55	
I _I	Input Leakage Current	$0 \le V_1 \le 5.5V$	2.3 – 3.6		±5.0	μΑ
loz	3-STATE Output Leakage	$0 \le V_O \le 5.5V$	2.3 – 3.6		±5.0	μА
		$V_I = V_{IH}$ or V_{IL}				μΛ
I _{OFF}	Power-Off Leakage Current	V_I or $V_O = 5.5V$	0	İ	10	μА

Note 4: I_O Absolute Maximum Rating must be observed.

DC Electrical Characteristics (Continued)

Symbol	Parameter	Conditions	V _{CC}	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		Units
Cymbol	i didilotoi	Conditions	(V)	Min	Max	Omio
I _{CC}	Quiescent Supply Current	$V_I = V_{CC}$ or GND	2.3 – 3.6		20	uА
		3.6V ≤ V _I , V _O ≤ 5.5V (Note 6)	2.3 – 3.6		±20	μΛ
ΔI_{CC}	Increase in I _{CC} per Input	$V_{IH} = V_{CC} - 0.6V$	2.3 – 3.6		500	μΑ

Note 6: Outputs disabled or 3-STATE only.

AC Electrical Characteristics

		$T_A = -40^{\circ}$ to $+85^{\circ}$ C, $R_L = 500\Omega$						
Symbol	Parameter	$V_{CC} = 3.3V \pm 0.3V$ $C_L = 50 \text{ pF}$		V _{CC} =	$V_{CC} = 2.7V$		$\rm V_{CC}=2.5V\pm0.2V$	
Syllibol	Farameter			C _L = 50 pF		C _L = 30 pF		Units
		Min	Max	Min	Max	Min	Max	
f _{MAX}	Maximum Clock Frequency	170						MHz
t _{PHL}	Propagation Delay	1.5	6.2	1.5	6.5	1.5	7.4	ns
t _{PLH}	CP to On	1.5	6.2	1.5	6.5	1.5	7.4	115
t _{PZL}	Output Enable time	1.5	6.1	1.5	6.3	1.5	7.9	ns
t _{PZH}		1.5	6.1	1.5	6.3	1.5	7.9	115
t _{PLZ}	Output Disable Time	1.5	6.0	1.5	6.2	1.5	7.2	ns
t _{PHZ}		1.5	6.0	1.5	6.2	1.5	7.2	115
t _S	Setup Time	2.5		2.5		3.0		ns
t _H	Hold Time	1.5		1.5		2.0		ns
t _W	Pulse Width	3.0		3.0		3.5		ns

Dynamic Switching Characteristics

Symbol	Parameter	Conditions	V _{CC}	T _A = 25°C	Units
Symbol	rarameter	Conditions	(V)	Typical	Onits
V _{OLP}	Quiet Output Dynamic Peak V _{OL}	$C_L = 50 \text{ pF}, V_{IH} = 3.3 \text{V}, V_{IL} = 0 \text{V}$	3.3	0.8	V
		$C_L = 30 \text{ pF}, V_{IH} = 2.5 \text{V}, V_{IL} = 0 \text{V}$	2.5	0.6	٧
V _{OLV}	Quiet Output Dynamic Valley V _{OL}	$C_L = 50 \text{ pF}, V_{IH} = 3.3 \text{V}, V_{IL} = 0 \text{V}$	3.3	-0.8	V
		$C_L = 30 \text{ pF}, V_{IH} = 2.5 \text{V}, V_{IL} = 0 \text{V}$	2.5	0.6	V

Capacitance

Symbol	Parameter	Conditions	Typical	Units
C _{IN}	Input Capacitance	$V_{CC} = Open, V_I = 0V \text{ or } V_{CC}$	7	pF
C _{OUT}	Output Capacitance	$V_{CC} = 3.3V$, $V_I = 0V$ or V_{CC}	8	pF
C _{PD}	Power Dissipation Capacitance	$V_{CC} = 3.3V$, $V_{I} = 0V$ or V_{CC} , $f = 10$ MHz	20	pF

AC LOADING and WAVEFORMS Generic for LCX Family

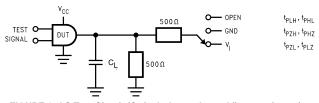
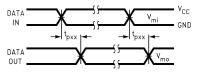
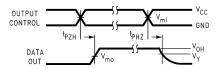


FIGURE 1. AC Test Circuit (C_L includes probe and jig capacitance)

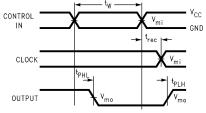
Test	Switch		
t _{PLH} , t _{PHL}	Open		
t _{PZL} , t _{PLZ}	6V at V_{CC} = 3.3 \pm 0.3V, and 2.7V V_{CC} x 2 at V_{CC} = 2.5 \pm 0.2V		
t_{PZH}, t_{PHZ}	GND		



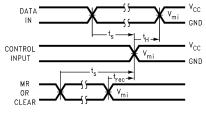
Waveform for Inverting and Non-Inverting Functions



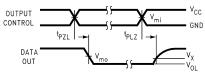
3-STATE Output High Enable and Disable Times for Logic



Propagation Delay. Pulse Width and t_{rec} Waveforms



Setup Time, Hold Time and Recovery Time for Logic



3-STATE Output Low Enable and Disable Times for Logic

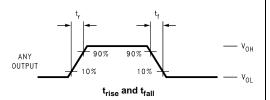
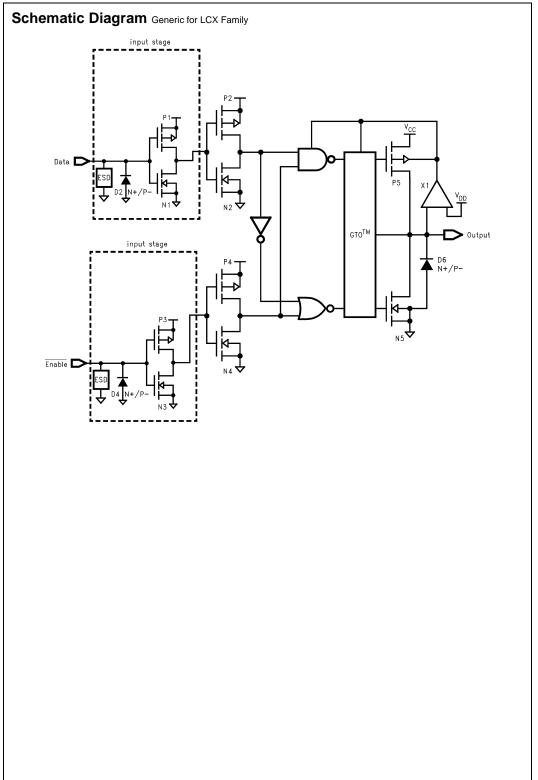


FIGURE 2. Waveforms (Input Characteristics; f =1MHz, $t_r = t_f = 3ns$)

Symbol	V _{cc}			
	$3.3V \pm 0.3V$	2.7V	2.5V ± 0.2V	
V _{mi}	1.5V	1.5V	V _{CC} /2	
V _{mo}	1.5V	1.5V	V _{CC} /2	
V _x	$V_{OL} + 0.3V$	V _{OL} + 0.3V	V _{OL} + 0.15V	
V _y	V _{OH} – 0.3V	V _{OH} – 0.3V	V _{OH} – 0.15V	



-(0.75)

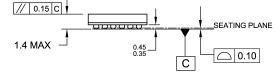
0.8

○ 0.10 B 5.5 (0.75) □ 0.10 A ABCDEFGHJKLMNPRT 0.4 13.5 12

Physical Dimensions inches (millimeters) unless otherwise noted

23456 96X 0.5^{+0.05} Top **Bottom** 0.15M C A B View 0.08M C View

PIN ONE



NOTES:

- A. THIS PACKAGE CONFORMS TO JEDEC M0-205
- B. ALL DIMENSIONS IN MILLIMETERS
- C. LAND PATTERN RECOMMENDATION: NSMD (Non Solder Mask Defined)
 .35MM DIA PADS WITH A SOLDERMASK OPENING OF .45MM CONCENTRIC TO PADS
 D. DRAWING CONFORMS TO ASME Y14.5M-1994

BGA96ArevE

96-Ball Fine-Pitch Ball Grid Array (FBGA), JEDEC MO-205, 5.5mm Wide Package Number BGA96A **Preliminary**

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